- Trimmed Offset Voltage:
  - TLC279 . . . 900  $\mu$ V Max at 25°C, V<sub>DD</sub> = 5 V
- Input Offset Voltage Drift . . . Typically
   0.1 μV/Month, Including the First 30 Days
- Wide Range of Supply Voltages Over Specified Temperature Range:

0°C to 70°C . . . 3 V to 16 V -40°C to 85°C . . . 4 V to 16 V -55°C to 125°C . . . 4 V to 16 V

- Single-Supply Operation
- Common-Mode Input Voltage Range Extends Below the Negative Rail (C-Suffix and I-Suffix Versions)
- Low Noise . . . Typically 25 nV/√Hz at f = 1 kHz
- Output Voltage Range Includes Negative Rail
- High Input Impedance . . .  $10^{12} \Omega$  Typ
- ESD-Protection Circuitry
- Small-Outline Package Option Also Available in Tape and Reel
- Designed-In Latch-Up Immunity

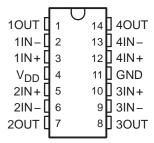
## description

The TLC274 and TLC279 quad operational amplifiers combine a wide range of input offset voltage grades with low offset voltage drift, high input impedance, low noise, and speeds approaching that of general-purpose BiFET devices.

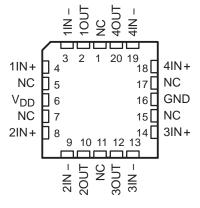
These devices use Texas Instruments silicongate LinCMOS™ technology, which provides offset voltage stability far exceeding the stability available with conventional metal-gate processes.

The extremely high input impedance, low bias currents, and high slew rates make these cost-effective devices ideal for applications which have previously been reserved for BiFET and NFET products. Four offset voltage grades are available (C-suffix and I-suffix types), ranging from the low-cost TLC274 (10 mV) to the high-precision TLC279 (900  $\mu\text{V}$ ). These advantages, in combination with good common-mode rejection and supply voltage rejection, make these devices a good choice for new state-of-the-art designs as well as for upgrading existing designs.

# D, J, N, OR PW PACKAGE (TOP VIEW)

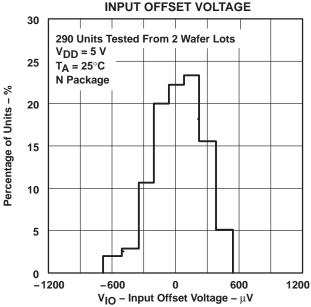


# FK PACKAGE (TOP VIEW)



NC - No internal connection

# DISTRIBUTION OF TLC279



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### description (continued)

In general, many features associated with bipolar technology are available on LinCMOS™ operational amplifiers, without the power penalties of bipolar technology. General applications such as transducer interfacing, analog calculations, amplifier blocks, active filters, and signal buffering are easily designed with the TLC274 and TLC279. The devices also exhibit low voltage single-supply operation, making them ideally suited for remote and inaccessible battery-powered applications. The common-mode input voltage range includes the negative rail.

A wide range of packaging options is available, including small-outline and chip-carrier versions for high-density system applications.

The device inputs and outputs are designed to withstand –100-mA surge currents without sustaining latch-up.

The TLC274 and TLC279 incorporate internal ESD-protection circuits that prevent functional failures at voltages up to 2000 V as tested under MIL-STD-883C, Method 3015.2; however, care should be exercised in handling these devices as exposure to ESD may result in the degradation of the device parametric performance.

The C-suffix devices are characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C. The I-suffix devices are characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C. The M-suffix devices are characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C.

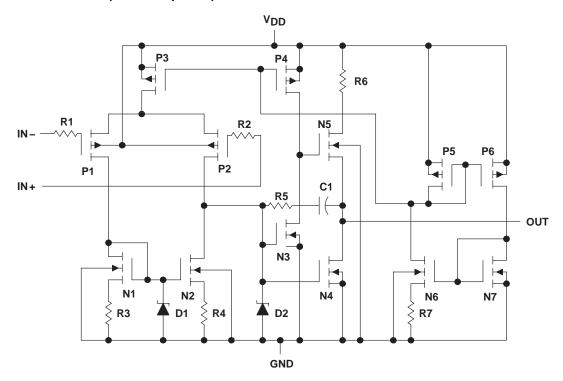
#### **AVAILABLE OPTIONS**

			PA	CKAGED DEV	ICES		CUID
TA	V <sub>IO</sub> max AT 25°C	SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (J)	PLASTIC DIP (N)	TSSOP (PW)	CHIP FORM (Y)
0°C to 70°C	900 μV 2 mV 5 mV 10 mV	TLC279CD TLC274BCD TLC274ACD TLC274CD	  -  -	_ _ _ _	TLC279CN TLC274BCN TLC274ACN TLC274CN	   TLC274CPW	   TLC274Y
-40°C to 85°C	900 μV 2 mV 5 mV 10 mV	TLC279ID TLC274BID TLC274AID TLC274ID		_ _ _ _	TLC279IN TLC274BIN TLC274AIN TLC274IN	_ _ _ _	_ _ _ _
−55°C to 125°C	900 μV 10 mV	TLC279MD TLC274MD	TLC279MFK TLC274MFK	TLC279MJ TLC274MJ	TLC279MN TLC274MN	_ _	

The D package is available taped and reeled. Add R suffix to the device type (e.g., TLC279CDR).



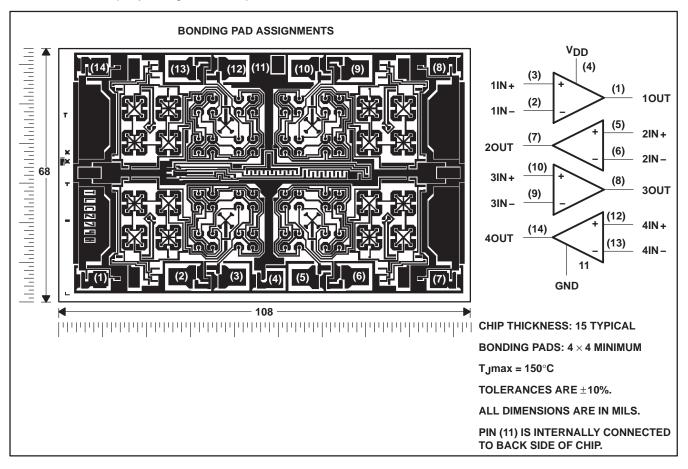
## equivalent schematic (each amplifier)



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### **TLC274Y chip information**

These chips, when properly assembled, display characteristics similar to the TLC274C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. Chips may be mounted with conductive epoxy or a gold-silicon preform.



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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>DD</sub> (see Note 1)	
Input voltage range, V <sub>I</sub> (any input)	0.3 V to V <sub>DD</sub>
Input current, I <sub>I</sub>	±5 mA
Output current, I <sub>O</sub> (each output)	±30 mA
Total current into V <sub>DD</sub>	45 mA
Total current out of GND	45 mA
Duration of short-circuit current at (or below) 25°C (see Note 3)	unlimited
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature, T <sub>A</sub> : C suffix	0°C to 70°C
I suffix	–40°C to 85°C
Mouffix	FF00 to 40F00
M suffix	55°C to 125°C
Storage temperature range	
	–65°C to 150°C
Storage temperature range	65°C to 150°C 260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.
  - 2. Differential voltages are at the noninverting input with respect to the inverting input.
  - 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded (see application section).

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING	T <sub>A</sub> = 125°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW	494 mW	_
FK	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
J	1375 mW	11.0 mW/°C	880 mW	715 mW	275 mW
N	1575 mW	12.6 mW/°C	1008 mW	819 mW	_
PW	700 mW	5.6 mW/°C	448 mW	_	_

### recommended operating conditions

		C SU	FFIX	I SUF	FIX	M SU	FFIX	
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
Supply voltage, V <sub>DD</sub>		3	16	4	16	4	16	V
	V <sub>DD</sub> = 5 V	-0.2	3.5	-0.2	3.5	0	3.5	.,
Common-mode input voltage, V <sub>IC</sub>	V <sub>DD</sub> = 10 V	-0.2	8.5	-0.2	8.5	0	8.5	V
Operating free-air temperature, TA		0	70	-40	85	-55	125	°C



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## electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$ (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	T <sub>A</sub> †	TLC274 TLC274			UNIT
						MIN	TYP	MAX	
		TI 00740	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		1.1	10	
		TLC274C	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			12	>/
		TI 007440	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		0.9	5	mV
l.,	Lawret affant on the ma	TLC274AC	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			6.5	
VIO	Input offset voltage	TI 0074D0	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		340	2000	
		TLC274BC	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			3000	
		TI 00700	V <sub>O</sub> = 1.4 V,	$V_{IC} = 0$ ,	25°C		320	900	μV
		TLC279C	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			1500	
αΛΙΟ	Average temperature coeffice offset voltage	ient of input			25°C to 70°C		1.8		μV/°C
	long to effect as most foca blat	- 4\			25°C		0.1	60	A
liO	Input offset current (see Note	e 4)	V 05.V	V 05V	70°C		7	300	рA
		4)	$V_0 = 2.5 \text{ V},$	V <sub>IC</sub> = 2.5 V	25°C		0.6	60	
IВ	Input bias current (see Note 4)				70°C		40	600	рA
						-0.2	-0.3		
					25°C	to 4	to		V
	Common-mode input voltage range (see Note 5)						4.2		
	(see Note 5)				Full range	-0.2 to			V
					l am ramiga	3.5			-
					25°C	3.2	3.8		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	0°C	3	3.8		V
					70°C	3	3.8		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	0°C		0	50	mV
					70°C		0	50	
					25°C	5	23		
AVD	Large-signal differential volta amplification	age	$V_0 = 0.25 \text{ V to 2 V},$	$R_L = 10 \text{ k}\Omega$	0°C	4	27		V/mV
	априновноп				70°C	4	20		
					25°C	65	80		
CMRR	Common-mode rejection rati	io	V <sub>IC</sub> = V <sub>ICR</sub> min		0°C	60	84		dB
					70°C	60	85		
		_			25°C	65	95		
k <sub>SVR</sub>	Supply-voltage rejection ratio (ΔV <sub>DD</sub> /ΔV <sub>IO</sub> )	0	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	0°C	60	94		dB
	(¬, DD, ¬, IO)				70°C	60	96		
					25°C		2.7	6.4	
I <sub>DD</sub>	Supply current (four amplifie	rs)		$V_{IC} = 2.5 \text{ V},$	0°C		3.1	7.2	mA
1			No load		70°C		2.3	5.2	

<sup>†</sup> Full range is 0°C to 70°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



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# electrical characteristics at specified free-air temperature, $V_{\mbox{DD}}$ = 10 V (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	T <sub>A</sub> †	TLC274	C, TLC2 BC, TLC		UNIT
						MIN	TYP	MAX	
		TI 00740	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		1.1	10	
		TLC274C	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			12	
		TI 007440	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		0.9	5	mV
.,		TLC274AC	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			6.5	
VIO	Input offset voltage	TI 0074D0	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		390	2000	
		TLC274BC	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			3000	
		TI 00700	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		370	1200	μV
		TLC279C	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			1900	
ανιο	Average temperature coeff input offset voltage	icient of			25°C to 70°C		2		μV/°C
					25°C		0.1	60	
liO	Input offset current (see No	ote 4)	.,		70°C		7	300	pA
			V <sub>O</sub> =.5 V,	VIC = 2 V	25°C		0.7	60	
I <sub>IB</sub>	Input bias current (see Not	e 4)			70°C		50	600	рA
	Common-mode input volta	ae range			25°C	-0.2 to	-0.3 to 9.2		V
VICR	(see Note 5)	gorungo			Full range	-0.2 to 8.5			V
					25°C	8	8.5		
Vон	High-level output voltage		V <sub>ID</sub> = 100 mV,	$R_L = 10 \text{ k}\Omega$	0°C	7.8	8.5		V
					70°C	7.8	8.4		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	0°C		0	50	mV
					70°C		0	50	
					25°C	10	36		
AVD	Large-signal differential vo amplification	Itage	$V_0 = 1 \ V \ to 6 \ V,$	$R_L = 10 \text{ k}\Omega$	0°C	7.5	42		V/mV
	amplification				70°C	7.5	32		
					25°C	65	85		
CMRR	Common-mode rejection ra	atio	V <sub>IC</sub> = V <sub>ICR</sub> min		0°C	60	88		dB
	•				70°C	60	88		
					25°C	65	95		
ksvr	Supply-voltage rejection ra (ΔV <sub>DD</sub> /ΔV <sub>IO</sub> )	tio	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	V <sub>O</sub> = 1.4 V	0°C	60	94		dB
	(7 A DD) (7 A IQ)				70°C	60	96		
					25°C		3.8	8	
$I_{DD}$	Supply current (four amplifiers)	Supply current (four amplifiers)		$V_{IC} = 5 V$	0°C		4.5	8.8	mA
		No load	1.10 1000		70°C		3.2	6.8	

<sup>†</sup>Full range is 0°C to 70°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



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## electrical characteristics at specified free-air temperature, V<sub>DD</sub> = 5 V (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	T <sub>A</sub> †		4I, TLC2 4BI, TL0		UNIT
						MIN	TYP		
		TI 00741	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		1.1	10	
		TLC274I	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			13	
		TI 007441	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		0.9	5	mV
1/	lanut effect veltere	TLC274AI	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			7	
VIO	Input offset voltage	TLC274BI	V <sub>O</sub> = 1.4 V,	$V_{IC} = 0$ ,	25°C		340	2000	
		TLG2/4BI	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			3500	μV
		TLC279I	$V_0 = 1.4 V$ ,	$V_{IC} = 0$ ,	25°C		320	900	μν
		11.02791	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			2000	
ανιο	Average temperature coeffice offset voltage	cient of input			25°C to 85°C		1.8		μV/°C
	lanut effect compat (one black	·- 4\			25°C		0.1	60	A
lio	Input offset current (see Not	(e 4)	V- 05V	V 0.5.V	85°C		24	1000	pA
1	lancet bing assument (and Nata	4)	$V_0 = 2.5 \text{ V},$	VIC = 2.5 V	25°C		0.6	60	A
I <sub>IB</sub>	Input bias current (see Note	4)			85°C		200	2000	pA
.,	Common-mode input voltage	e range			25°C	-0.2 to 4	-0.3 to 4.2		V
VICR	Common-mode input voltage ICR (see Note 5)				Full range	-0.2 to 3.5			٧
					25°C	3.2	3.8		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	-40°C	3	3.8		V
					85°C	3	3.8		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	−40°C		0	50	mV
					85°C		0	50	
	l anno airmal differential cale				25°C	5	23		
AVD	Large-signal differential volt amplification	age	$V_0 = 0.25 \text{ V to 2 V},$	$R_L = 10 \text{ k}\Omega$	-40°C	3.5	32		V/mV
					85°C	3.5	19		
					25°C	65	80		
CMRR	Common-mode rejection rate	tio	$V_{IC} = V_{ICR}min$		−40°C	60	81		dB
					85°C	60	86		
	Cumply voltage releasing and	_			25°C	65	95		
ksvr	Supply-voltage rejection rati (ΔVDD/ΔVIO)	U	$V_{DD} = 5 V \text{ to } 10 V,$	$V_0 = 1.4 \text{ V}$	−40°C	60	92		dB
	· DD: 10/				85°C	60	96		
			V- 25V	\/ 0.E.\/	25°C		2.7	6.4	
$I_{DD}$	Supply current (four amplifie	supply current (four amplifiers) $V_O = 2.5 \text{ V}$ , No load	-	$V_{IC} = 2.5 V,$	−40°C		3.8	8.8	mA
					85°C		2.1	4.8	

<sup>†</sup> Full range is –40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



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# electrical characteristics at specified free-air temperature, $V_{\mbox{DD}}$ = 10 V (unless otherwise noted)

No		PARAMETER		TEST CONI	DITIONS	T <sub>A</sub> †		4I, TLC2 4BI, TL0		UNIT
No N							MIN	TYP	MAX	
No			TI C0741			25°C		1.1	10	
No N			TLG2/41	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			13	>/
No			TI 007441	$V_0 = 1.4 V$	$V_{IC} = 0$ ,	25°C		0.9	5	mv
TLC274Bl   Rs = 50 Ω, Rl = 10 kΩ   Full range   350 Ω   70	,,	Land offertualtens	TLC274AI	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			7	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	VIO	input offset voltage	TI 0074DI	V <sub>O</sub> = 1.4 V,	$V_{IC} = 0$ ,	25°C		390	2000	
TLC279			TLC274BI	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			3500	
Average temperature coefficient of input offset voltage   Part of Service   Part			TI 00701	V <sub>O</sub> = 1.4 V,	$V_{IC} = 0$ ,	25°C		370	1200	μν
Input offset current (see Note 4)   VO = 5 V,   VIC = 5 V   VIC			1LC2/91	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			2900	
Input offset current (see Note 4)	ανιο		ent of input					2		μV/°C
No = 5 V,   Vic = 5 V   Se <sup>5</sup> C   226   100   No   No   No   No   No   No   No		Land offert comment (see Note	4)			25°C		0.1	60	A
Input bias current (see Note 4)   85°C   220   2000   PA	IO	input offset current (see Note	4)			85°C		26	1000	pА
$V_{ICR} = \begin{array}{c} & 85^{\circ}C \\ & 220 \\ & 200 \\ & 25^{\circ}C \\ & 10 \\ & 10 \\ & 9 \\ & 9.2 \\ & & & & & & & & & & & & & & & & & & $				$V_O = 5 V$	VIC = 2 V	25°C		0.7	60	
$V_{ICR} = \begin{array}{c} Common-mode input voltage range \\ (see Note 5) \end{array} \\ \begin{array}{c} V_{ICR} = \begin{array}{c} Common-mode input voltage range \\ (see Note 5) \end{array} \\ \begin{array}{c} V_{ID} = 100  \text{mV}, \\ V_{ID}$	IB	Input bias current (see Note 4	1)			85°C		220	2000	рA
$\begin{array}{c} V_{ICR} \\ V_{OH} \\ V_{O$							-0.2	-0.3		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$						25°C				V
$V_{OH}  \text{High-level output voltage} \qquad V_{ID} = 100  \text{mV},  R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{8.5} \qquad 8.8.5 \qquad V$ $V_{OL}  \text{Low-level output voltage} \qquad V_{ID} = -100  \text{mV},  I_{OL} = 0 \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad \frac{8.8.5}{7.8} \qquad \frac{8.5}{85^{\circ}} \qquad V$ $V_{OL}  \text{Low-level output voltage} \qquad V_{ID} = -100  \text{mV},  I_{OL} = 0 \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \text{mV}$ $R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \frac{35^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \frac{35^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \frac{35^{\circ}\text{C}}{85^{\circ}\text{C}} \qquad 0.50  \frac{35^{\circ}\text{C}}{85^{\circ$	1/100							9.2		
$V_{OH}  \text{High-level output voltage} \qquad V_{ID} = 100  \text{mV},  R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}}  \frac{8}{8.5}  \frac{8.5}{5} \qquad V$ $V_{OL}  \text{Low-level output voltage} \qquad V_{ID} = -100  \text{mV},  I_{OL} = 0 \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}}  \frac{0}{50}  \frac{50}{50}  \text{mV}$ $V_{OL}  \text{Low-level output voltage} \qquad V_{ID} = -100  \text{mV},  I_{OL} = 0 \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}}  \frac{0}{50}  \frac{50}{50}  \text{mV}$ $A_{VD}  \text{Large-signal differential voltage amplification} \qquad V_{O} = 1  \text{V to 6 V},  R_L = 10  \text{k}\Omega \qquad \frac{25^{\circ}\text{C}}{85^{\circ}\text{C}}  \frac{10}{36}  \frac{36}{50}  \frac{36}{50}$		(See Note 3)	Note 5)			Full range				V
$\begin{array}{c} V_{OH}  \mbox{High-level output voltage} \\ V_{ID} = 100 \ \mbox{mV}, \qquad R_L = 10 \ \mbox{k}\Omega \\ \hline \\ V_{OL}  \mbox{Low-level output voltage} \\ \hline \\ V_{OL}  \mbox{Low-level output voltage} \\ \hline \\ V_{ID} = -100 \ \mbox{mV}, \qquad I_{OL} = 0 \\ \hline \\ V_{ID} = -100 \ \mbox{mV}, \qquad I_{OL} = 0 \\ \hline \\ \mbox{RL} = 10 \ \mbox{k}\Omega \\ \hline \\ \mbox{RL} = 10 \ \mbox{k}\Omega \\ \hline \\ \mbox{Large-signal differential voltage} \\ \mbox{amplification} \\ \hline \\ \mbox{VO} = 1 \ \mbox{V to 6 V}, \qquad R_L = 10 \ \mbox{k}\Omega \\ \hline \\ \mbox{RL} = 10 \ \mbox{k}\Omega \\ \hline \\ \mbox$										-
$V_{OL}  \text{Low-level output voltage} \qquad V_{ID} = -100  \text{mV},  I_{OL} = 0 \qquad \begin{array}{c} 85^{\circ}\text{C} & 7.8 & 8.5 \\ \hline 25^{\circ}\text{C} & 0 & 50 \\ \hline 85^{\circ}\text{C} & 0 & 50 \\ \hline 85^{\circ}\text{C} & 0 & 50 \\ \hline \end{array} \qquad \text{mV}$ $A_{VD}  \text{Large-signal differential voltage amplification} \qquad V_{O} = 1  \text{V to 6 V},  R_{L} = 10  \text{k}\Omega \qquad \begin{array}{c} 25^{\circ}\text{C} & 10 & 36 \\ \hline -40^{\circ}\text{C} & 7 & 47 \\ \hline 85^{\circ}\text{C} & 7 & 31 \\ \hline 25^{\circ}\text{C} & 65 & 85 \\ \hline -40^{\circ}\text{C} & 60 & 87 \\ \hline \end{array} \qquad V_{ID} = 0 \qquad \begin{array}{c} 0.5  \text{V}_{ID} = 0  \text{mV} \\ \hline 0.5  \text{MeV} \\ \hline 0.5  Me$						25°C	8	8.5		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	-40°C	7.8	8.5		V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$						85°C	7.8	8.5		
						25°C		0	50	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	-40°C		0	50	mV
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$						85°C		0	50	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$						25°C	10	36		
	AVD		ge	$V_0 = 1 \ V \ to 6 \ V,$	$R_L = 10 \text{ k}\Omega$	-40°C	7	47		V/mV
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		amplification			_	85°C	7	31		
$k_{SVR}  \begin{array}{c} \text{Supply-voltage rejection ratio} \\ \text{($\Delta V_{DD}/\Delta V_{IO})} \end{array} \qquad \begin{array}{c} V_{DD} = 5 \text{ V to 10 V},  V_{O} = 1.4 \text{ V} \\ \hline \\ V_{DD} = 5 \text{ V to 10 V},  V_{O} = 1.4 \text{ V} \\ \hline \\ \text{($\Delta V_{DD}/\Delta V_{IO})} \end{array} \qquad \begin{array}{c} 25^{\circ}\text{C} & 65 & 95 \\ \hline \\ -40^{\circ}\text{C} & 60 & 92 \\ \hline \\ 85^{\circ}\text{C} & 60 & 96 \\ \hline \\ \text{($\Delta V_{DD}/\Delta V_{IO})} \end{array} \qquad \text{dB}$ $V_{O} = 5 \text{ V}, \qquad V_{IC} = 5 \text{ V}, \qquad V_{IC}$						25°C	65	85		
	CMRR	Common-mode rejection ratio	)	V <sub>IC</sub> = V <sub>ICR</sub> min		-40°C	60	87		dB
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		·				85°C	60	88		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$						-	65	95		
Supply current (four amplifiers)   V <sub>O</sub> = 5 V, No load   V <sub>IC</sub> =	ksvr			$V_{DD} = 5 \text{ V to } 10 \text{ V},$	V <sub>O</sub> = 1.4 V	-40°C	60	92		dB
$V_{O} = 5 \text{ V},$ $V_{IC} = 5 \text{ V},$ $V_{IC} = 5 \text{ V},$ No load $V_{O} = 5 \text{ V},$ No load		(σΛΩΩ\σΛΙΟ)			•	85°C	60	96		
No load				1		25°C		3.8	8	
110 1080	IDD	Supply current (four amplifiers	s)		$V_{IC} = 5 V$ ,	-40°C		5.5	10	mA
				140 1090		85°C		2.9	6.4	

<sup>†</sup>Full range is -40°C to 85°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



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## electrical characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$ (unless otherwise noted)

	PARAMETER		<b>TEOT</b> 6.5	NITIONIO	- +	TLC27	4M, TLC	279M	
	PARAMETER		TEST CONI	DITIONS	T <sub>A</sub> †	MIN	TYP	MAX	UNIT
		TI 007414	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		1.1	10	>/
\ \ \ \ -	lanut effect valtage	TLC274M	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			12	mV
VIO	Input offset voltage	TI 0070M	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		320	900	
		TLC279M	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			3750	μV
ανιο	Average temperature coefficie offset voltage	nt of input			25°C to 125°C		2.1		μV/°C
1	Input offset surrent (see Note	4)			25°C		0.1	60	рА
lio	Input offset current (see Note	4)	0.5.V	V 0.5.V	125°C		1.4	15	nA
	land the land as summer to the Allege		$V_0 = 2.5 V$ ,	AIC = 5.2 A	25°C		0.6	60	рА
IB	Input bias current (see Note 4	)			125°C		9	35	nA
.,	Common-mode input voltage	range			25°C	0 to 4	-0.3 to 4.2		V
VICR	(see Note 5)	C			Full range	0 to 3.5			V
					25°C	3.2	3.8		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	−55°C	3	3.8		V
					125°C	3	3.8		
					25°C		0	50	
$V_{OL}$	Low-level output voltage		$V_{1D} = -100 \text{ mV},$	$I_{OL} = 0$	−55°C		0	50	mV
					125°C		0	50	
					25°C	5	23		
AVD	Large-signal differential voltage amplification	е	$V_0 = 0.25 \text{ V to 2 V},$	$R_L = 10 \text{ k}\Omega$	−55°C	3.5	35		V/mV
	amplification				125°C	3.5	16		
					25°C	65	80		
CMRR	Common-mode rejection ratio		V <sub>IC</sub> = V <sub>ICR</sub> min		−55°C	60	81		dB
					125°C	60	84		
	Our about the manufact of				25°C	65	95		
ksvr	Supply-voltage rejection ratio (ΔV <sub>DD</sub> /ΔV <sub>IO</sub> )		$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \ V$	−55°C	60	90		dB
	(— · UU/ — · IU/				125°C	60	97		
			V 0.5.V		25°C		2.7	6.4	
$I_{DD}$	Supply current (four amplifiers	)	V <sub>O</sub> = 2.5 V, No load	$V_{IC} = 2.5 V$ ,	−55°C		4	10	mA
					125°C		1.9	4.4	

<sup>†</sup> Full range is  $-55^{\circ}$ C to  $125^{\circ}$ C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.

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## electrical characteristics at specified free-air temperature, V<sub>DD</sub> = 10 V (unless) otherwise noted)

			TEST CONDITIONS  TA <sup>†</sup> TLC274M, TLC279M  MIN TYP MAX		279M				
	PARAMETER		TEST CONI	DITIONS	TAI	MIN	TYP	MAX	UNIT
		TI 007414	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		1.1	10	>/
,	land offers wellen	TLC274M	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			12	mV
VIO	Input offset voltage	TI 0070M	V <sub>O</sub> = 1.4 V,	V <sub>IC</sub> = 0,	25°C		370	1200	
		TLC279M	$R_S = 50 \Omega$ ,	$R_L = 10 \text{ k}\Omega$	Full range			4300	μV
αΛΙΟ	Average temperature coefficie offset voltage	ent of input			25°C to 125°C		2.2		μV/°C
1	Innut offeet ourrent (one Note	4)			25°C		0.1	60	pА
lio	Input offset current (see Note	4)	V <sub>O</sub> = 5 V,	\/ <b>  .</b>	125°C		1.8	15	nA
lin.	Input bigg ourrent (age Note 4	١	VO = 2V	$V_{IC} = 5 V$	25°C		0.7	60	рА
IB	Input bias current (see Note 4	)			125°C		10	35	nA
.,	Common-mode input voltage	range			25°C	0 to 9	-0.3 to 9.2		V
VICR	(see Note 5)	Ü			Full range	0 to 8.5			V
					25°C	8	8.5		
Vон	High-level output voltage		$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	−55°C	7.8	8.5		V
					125°C	7.8	8.4		
					25°C		0	50	
VOL	Low-level output voltage		$V_{ID} = -100 \text{ mV},$	$I_{OL} = 0$	−55°C		0	50	mV
					125°C		0	50	
	Laura d'anal d'étana d'al calca				25°C	10	36		
$A_{VD}$	Large-signal differential voltage amplification	je	$V_{O} = 1 \text{ V to 6 V},$	$R_L = 10 \text{ k}\Omega$	−55°C	7	50		V/mV
	атриноалогі				125°C	7	27		
					25°C	65	85		
CMRR	Common-mode rejection ratio		VIC = VICRmin		−55°C	60	87		dB
					125°C	60	86		
	Owner have the many that the state of				25°C	65	95		
ksvr	Supply-voltage rejection ratio (ΔV <sub>DD</sub> /ΔV <sub>IO</sub> )		$V_{DD} = 5 \text{ V to } 10 \text{ V},$	$V_0 = 1.4 \text{ V}$	−55°C	60	90		dB
	(-· UU/ IU/				125°C	60	97		
			.,		25°C		3.8	8	
IDD	Supply current (four amplifiers	s)	$V_O = 5 V$ , No load	$V_{IC} = 5 V$	−55°C		6.0	12	mA
					125°C		2.5	5.6	

<sup>†</sup>Full range is -55°C to 125°C.

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.



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## operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

	PARAMETER	TEST CO	TEST CONDITIONS			TLC274C, TLC274AC, TLC274AC, TLC274BC, TLC279C			
					MIN	TYP	MAX		
				25°C		3.6			
			V <sub>IPP</sub> = 1 V	0°C		4			
	Class and a structure and a	$R_L = 10 \Omega$ ,		70°C		3		\//··•	
SR	Slew rate at unity gain	C <sub>L</sub> = 20 <sub>P</sub> F, See Figure 1		25°C		2.9		V/μs	
		0	V <sub>IPP</sub> = 2.5 V	0°C		3.1			
				70°C		2.5			
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$ ,	25°C		25		nV/√ <del>Hz</del>	
				25°C		320			
ВОМ	Maximum output-swing bandwidth	$V_O = V_{OH}$ , $R_L = 10 \text{ k}\Omega$ ,	C <sub>L</sub> = 20 pF, See Figure 1	0°C		340		kHz	
		TC   TO K22,	oco i iguio i	70°C		260			
		.,,		25°C		1.7			
В1	Unity-gain bandwidth	V <sub>I</sub> = 10 mV, See Figure 3	$C_L = 20 PF$ ,	0°C		2		MHz	
		Occ rigare o		70°C		1.3			
				25°C		46°			
φm		$V_{I} = 10 \text{ mV},$ $C_{L} = 20 \text{ pF},$		0°C	47°				
		оц – 20 рг,		70°C		44°			

## operating characteristics at specified free-air temperature, $V_{DD} = 10 \text{ V}$

	PARAMETER	TEST CO	NDITIONS	т <sub>А</sub>	TLC274 TL TLC274	UNIT		
					MIN	TYP	MAX	
				25°C		5.3		
			V <sub>IPP</sub> = 1 V	0°C		5.9		
CD	Clausesta at units gain	$R_L = 10 \Omega$ ,		70°C		4.3		\//v.o
SR	Slew rate at unity gain	C <sub>L</sub> = 20 pF, See Figure 1		25°C		4.6		V/μs
			V <sub>IPP</sub> = 5.5 V	0°C	5.1			]
				70°C		3.8		
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$ ,	25°C		25		nV/√ <del>Hz</del>
				25°C		200		
Вом	Maximum output-swing bandwidth	$V_O = V_{OH}$ , $R_L = 10 \text{ k}\Omega$ ,	CL = 20 pF,	0°C		220		kHz
		TC = 10 K22,	occ riguic i	70°C		140		
				25°C		2.2		
B <sub>1</sub>	Unity-gain bandwidth	V <sub>I</sub> = 10 mV, See Figure 3	$C_L = 20 pF$ ,	0°C		2.5		MHz
		occ rigure 3		70°C		1.8		
	_			25°C		49°		
φm	Phase margin	$V_{I} = 10 \text{ mV},$ $C_{L} = 20 \text{ pF},$	f = B <sub>1</sub> , See Figure 3	0°C		50°		
		OL - 20 Pr,	occ i igaic o	70°C		46°		

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# operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

	PARAMETER	TEST CO	TEST CONDITIONS			4I, TLC2 4BI, TL0		UNIT					
				TA	MIN	TYP	MAX						
				25°C		3.6							
			V <sub>IPP</sub> = 1 V	-40°C		4.5							
CD.	Class note at smits, main	$R_L = 10 \text{ k}\Omega$ , $C_L = 20 \text{ pF}$ , See Figure 1				85°C		2.8		Mhia			
SR	Slew rate at unity gain			25°C		2.9		V/μs					
		3	V <sub>IPP</sub> = 2.5 V	-40°C		3.5							
					85°C		2.3						
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$ ,	25°C		25		nV/√ <del>Hz</del>					
				25°C		320							
ВОМ	Maximum output-swing bandwidth	$R_L = 10 \text{ k}\Omega$ , See Figure 1	$V_O = V_{OH}$	aximum output-swing bandwidth $V_O = V_{OH}$ ,	CL = 20 pF, See Figure 1	-40°C		380		kHz			
			85°C		250								
				25°C		1.7							
В1	Unity-gain bandwidth	V <sub>I</sub> = 10 mV, See Figure 3	$C_L = 20 pF$ ,	-40°C		2.6		MHz					
			occ riguic o				85°C		1.2				
			$V_1 = 10 \text{ mV},  f = B_1,$	25°C		46°							
$\phi_{m}$	Phase margin						$V_{I} = 10 \text{ mV},$ $C_{L} = 20 \text{ pF},$				-40°C		49°
		OL - 25 Pr,	CCC Figure 5	85°C		43°							

# operating characteristics at specified free-air temperature, $V_{\mbox{DD}}$ = 10 V

PARAMETER		PARAMETER TEST CONDITIONS		TA	TLC274I, TLC2 TLC274BI, TL		UNIT								
					MIN TYP	MAX									
				25°C	5.3										
			V <sub>IPP</sub> = 1 V	-40°C	6.7										
CD.	Class note at smits, main	$R_L = 10 \Omega$ ,		85°C	4		\//··•								
SR	Slew rate at unity gain	C <sub>L</sub> = 20 <sub>P</sub> F, See Figure 1		25°C	4.6		V/μs								
			V <sub>IPP</sub> = 5.5 V	-40°C	5.8										
					85°C	85°C	3.5								
V <sub>n</sub>	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$ ,	25°C	25		nV/√ <del>Hz</del>								
		V <sub>O</sub> = V <sub>OH</sub> ,		25°C	200										
Вом	Maximum output-swing bandwidth			C <sub>L</sub> = 20 pF, See Figure 1	-40°C	260		kHz							
		N_ = 10 K32,	occ riguic r	85°C	130										
				25°C	2.2										
B <sub>1</sub>	Unity-gain bandwidth	V <sub>I</sub> = 10 mV, See Figure 3	$C_L = 20 pF$ ,	-40°C	3.1		MHz								
		Goo i igaic o	85°C	1.7											
		., .,	, 5	25°C	49°										
φm	Phase margin		$V_{ } = 10 \text{ mV},$					V <sub>I</sub> = 10 mV, C <sub>L</sub> = 20 pF,			f = B <sub>1</sub> , See Figure 3	-40°C	52°		
		CL = 20 pr, See rigure 3		85°C	46°										

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# operating characteristics at specified free-air temperature, $V_{DD} = 5 \text{ V}$

	DADAMETED			_	TLC274	TLC274M, TLC279M									
	PARAMETER	IESI CO	NDITIONS	TA	MIN	TYP	MAX	UNIT							
				25°C		3.6									
			V <sub>IPP</sub> = 1 V	−55°C		4.7									
	Olements at write and	$R_L = 10 \text{ k}\Omega$ ,		125°C		2.3		\// -							
SR	Slew rate at unity gain	C <sub>L</sub> = 20 pF, See Figure 1 V <sub>IPP</sub> = 2.5 V		25°C		2.9		V/μs							
			V <sub>IPP</sub> = 2.5 V	−55°C		3.7									
				125°C		2									
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$ ,	25°C		25		nV/√ <del>Hz</del>							
			V <sub>O</sub> = V <sub>OH</sub> , C <sub>L</sub>			$V_O = V_{OH},$ $R_L = 10 \text{ k}\Omega,$			25°C		320				
ВОМ	Maximum output-swing bandwidth							C <sub>L</sub> = 20 <sub>P</sub> F, See Figure 1	−55°C		400		kHz		
			See rigule i	125°C		230									
				25°C		1.7									
B <sub>1</sub>	Unity-gain bandwidth	nity-gain bandwidth $V_{\parallel} = 10 \text{ mV},  C_{L} = 20 \text{ pF},$ See Figure 3	$C_L = 20 pF$ ,	−55°C		2.9		MHz							
		Occ rigure 3		125°C		1.1									
				25°C		46°									
$\phi_{\text{m}}$	Phase margin										−55°C		49°		
				125°C		41°									

# operating characteristics at specified free-air temperature, $V_{DD}$ = 10 V

	DADAMETER	<b></b>	NETIONS	_	TLC274	IM, TLC	279M								
	PARAMETER	IEST CO	NDITIONS	TA	MIN	TYP	MAX	UNIT							
				25°C		5.3									
			V <sub>IPP</sub> = 1 V	−55°C		7.1									
	Olemante et malte male	$R_L = 10 \Omega$ , $125^{\circ}C$	125°C		3.1		\// -								
SR	Slew rate at unity gain	V <sub>IPP</sub> = 5.5 V		25°C		4.6		V/μs							
			V <sub>IPP</sub> = 5.5 V	−55°C		6.1									
			125°C		2.7										
Vn	Equivalent input noise voltage	f = 1 kHz, See Figure 2	$R_S = 20 \Omega$ ,	25°C		25		nV/√ <del>Hz</del>							
		$R_{L} = 10 \text{ k}\Omega$ , See Figure 1	$V_O = V_{OH},$ $C_L = 20 \text{ pF},$ $R_L = 10 \text{ k}\Omega,$ See Figure 1			25°C		200							
Вом	Maximum output-swing bandwidth											C <sub>L</sub> = 20 pF, See Figure 1	−55°C		280
	N 10 K22			125°C		110		1							
				25°C		2.2									
B <sub>1</sub>	Unity-gain bandwidth	V <sub>I</sub> = 10 mV, See Figure 3	$C_L = 20 pF$ ,	−55°C		3.4		MHz							
		Gee rigule 3		125°C		1.6									
				25°C		49°									
$\phi_{\text{m}}$	Phase margin								f = B <sub>1</sub> , See Figure 3	−55°C		52°			
			occ rigule 3	125°C		44°									

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# electrical characteristics, $V_{DD}$ = 5 V, $T_A$ = 25°C (unless otherwise noted)

	DADAMETED	TEST SOME	TEST CONDITIONS		LC274Y		
	PARAMETER	TEST CONL			TYP	MAX	UNIT
VIO	Input offset voltage	$V_{O} = 1.4 \text{ V},$ $R_{S} = 50 \Omega,$	$V_{IC} = 0,$ $R_L = 10 \text{ k}\Omega$		1.1	10	mV
IIO	Input offset current (see Note 4)	V 05V	V 25V		0.1		рА
I <sub>IB</sub>	Input bias current (see Note 4)	$V_{O} = 2.5 \text{ V},$	$V_{IC} = 2.5 V$		0.6		рА
VICR	Common-mode input voltage range (see Note 5)			-0.2 to 4	-0.3 to 4.2		V
Vон	High-level output voltage	$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	3.2	3.8		V
VOL	Low-level output voltage	$V_{ID} = -100 \text{ mV},$	I <sub>OL</sub> = 0		0	50	mV
AVD	Large-signal differential voltage amplification	$V_0 = 0.25 \text{ V to 2 V},$	$R_L = 10 \text{ k}\Omega$	5	23		V/mV
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}min$		65	80		dB
ksvr	Supply-voltage rejection ratio (ΔV <sub>DD</sub> /ΔV <sub>IO</sub> )	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	V <sub>O</sub> = 1.4 V	65	95		dB
I <sub>DD</sub>	Supply current (four amplifiers)	V <sub>O</sub> = 2.5 V, No load	V <sub>IC</sub> = 2.5 V,		2.7	6.4	mA

# electrical characteristics, $V_{DD}$ = 10 V, $T_A$ = 25°C (unless otherwise noted)

DADAMETED		TEST 6611	NITIONIO.	Т	LC274Y		
	PARAMETER	TEST CONL	TEST CONDITIONS		TYP	MAX	UNIT
V <sub>IO</sub>	Input offset voltage	$V_{O} = 1.4 \text{ V},$ RS = 50 $\Omega$ ,	$V_{IC} = 0,$ $R_L = 10 \text{ k}\Omega$		1.1	10	mV
I <sub>IO</sub>	Input offset current (see Note 4)	,, 5,,			0.1		pA
I <sub>IB</sub>	Input bias current (see Note 4)	$V_{O} = 5 V$ ,	$V_{IC} = 5 V$		0.7		pA
VICR	Common-mode input voltage range (see Note 5)			-0.2 to 9	-0.3 to 9.2		V
Vон	High-level output voltage	$V_{ID} = 100 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	8	8.5		V
VOL	Low-level output voltage	$V_{ID} = -100 \text{ mV},$	I <sub>OL</sub> = 0		0	50	mV
AVD	Large-signal differential voltage amplification	$V_0 = 1 \ V \ to \ 6 \ V,$	R <sub>L</sub> = 10 kΩ	10	36		V/mV
CMRR	Common-mode rejection ratio	V <sub>IC</sub> = V <sub>ICR</sub> min		65	85		dB
ksvr	Supply-voltage rejection ratio (ΔV <sub>DD</sub> /ΔV <sub>IO</sub> )	$V_{DD} = 5 \text{ V to } 10 \text{ V},$	V <sub>O</sub> = 1.4 V	65	95		dB
I <sub>DD</sub>	Supply current (four amplifiers)	V <sub>O</sub> = 5 V, No load	V <sub>IC</sub> = 5 V,	·	3.8	8	mA

NOTES: 4. The typical values of input bias current and input offset current below 5 pA were determined mathematically.

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# operating characteristics, $V_{DD}$ = 5 V, $T_A$ = 25°C

PARAMETER		_	TEST COMPLIANC		TLC274Y			LINUT		
		'	TEST CONDITIONS			TYP	MAX	UNIT		
CD	Clause at waits are in	$R_L = 10 \text{ k}\Omega$ ,	C <sub>L</sub> = 20 pF,	V <sub>IPP</sub> = 1 V		3.6		Miss		
SR	Slew rate at unity gain	See Figure 1		See Figure 1		$V_{IPP} = 2.5 V$		2.9		V/μs
Vn	Equivalent input noise voltage	f = 1  kHz,	$R_S = 20 \Omega$ ,	See Figure 2		25		nV/√ <del>Hz</del>		
ВОМ	Maximum output-swing bandwidth	V <sub>O</sub> = V <sub>OH</sub> , See Figure 1	$C_L = 20 pF$ ,	$R_L = 10 \text{ k}\Omega$ ,		320		kHz		
B <sub>1</sub>	Unity-gain bandwidth	$V_I = 10 \text{ mV},$	C <sub>L</sub> = 20 pF,	See Figure 3		1.7		MHz		
φm	Phase margin	V <sub>I</sub> = 10 mV, See Figure 3	f = B <sub>1</sub> ,	C <sub>L</sub> = 20 pF,		46°				

# operating characteristics, $V_{DD}$ = 10 V, $T_A$ = 25°C

PARAMETER		,	TEST CONDITIONS			TLC274Y		
	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT	
SR	Clausesta at units sain			V <sub>IPP</sub> = 1 V		5.3		Muo
SK	Slew rate at unity gain			V <sub>IPP</sub> = 5.5 V		4.6		V/μs
Vn	Equivalent input noise voltage	f = 1  kHz,	$R_S = 20 \Omega$ ,	See Figure 2		25		nV/√ <del>Hz</del>
ВОМ	Maximum output-swing bandwidth	V <sub>O</sub> = V <sub>OH</sub> , See Figure 1	$C_L = 20 pF$ ,	$R_L = 10 \text{ k}\Omega$ ,		200		kHz
B <sub>1</sub>	Unity-gain bandwidth	V <sub>I</sub> = 10 mV,	C <sub>L</sub> = 20 <sub>P</sub> F,	See Figure 3		2.2		MHz
φm	Phase margin	V <sub>I</sub> = 10 mV, See Figure 3	f = B <sub>1</sub> ,	$C_L = 20 pF$ ,		49°		

#### PARAMETER MEASUREMENT INFORMATION

## single-supply versus split-supply test circuits

Because the TLC274 and TLC279 are optimized for single-supply operation, circuit configurations used for the various tests often present some inconvenience since the input signal, in many cases, must be offset from ground. This inconvenience can be avoided by testing the device with split supplies and the output load tied to the negative rail. A comparison of single-supply versus split-supply test circuits is shown below. The use of either circuit gives the same result.

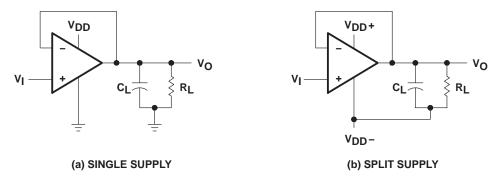


Figure 1. Unity-Gain Amplifier

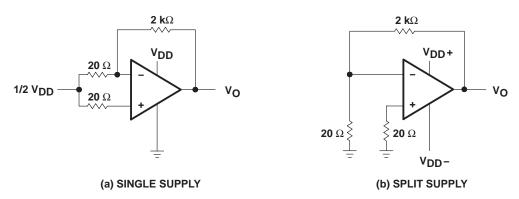


Figure 2. Noise-Test Circuit

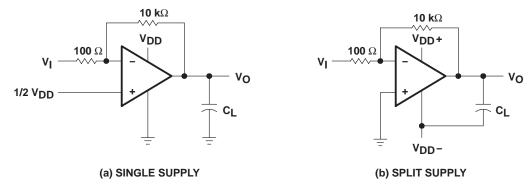


Figure 3. Gain-of-100 Inverting Amplifier

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#### PARAMETER MEASUREMENT INFORMATION

#### input bias current

Because of the high input impedance of the TLC274 and TLC279 operational amplifiers, attempts to measure the input bias current can result in erroneous readings. The bias current at normal room ambient temperature is typically less than 1 pA, a value that is easily exceeded by leakages on the test socket. Two suggestions are offered to avoid erroneous measurements:

- 1. Isolate the device from other potential leakage sources. Use a grounded shield around and between the device inputs (see Figure 4). Leakages that would otherwise flow to the inputs are shunted away.
- 2. Compensate for the leakage of the test socket by actually performing an input bias current test (using a picoammeter) with no device in the test socket. The actual input bias current can then be calculated by subtracting the open-socket leakage readings from the readings obtained with a device in the test socket.

One word of caution: many automatic testers as well as some bench-top operational amplifier testers use the servo-loop technique with a resistor in series with the device input to measure the input bias current (the voltage drop across the series resistor is measured and the bias current is calculated). This method requires that a device be inserted into the test socket to obtain a correct reading; therefore, an open-socket reading is not feasible using this method.

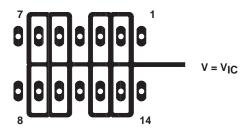


Figure 4. Isolation Metal Around Device Inputs (J and N packages)

#### low-level output voltage

To obtain low-supply-voltage operation, some compromise was necessary in the input stage. This compromise results in the device low-level output being dependent on both the common-mode input voltage level as well as the differential input voltage level. When attempting to correlate low-level output readings with those quoted in the electrical specifications, these two conditions should be observed. If conditions other than these are to be used, please refer to Figures 14 through 19 in the Typical Characteristics of this data sheet.

#### input offset voltage temperature coefficient

Erroneous readings often result from attempts to measure temperature coefficient of input offset voltage. This parameter is actually a calculation using input offset voltage measurements obtained at two different temperatures. When one (or both) of the temperatures is below freezing, moisture can collect on both the device and the test socket. This moisture results in leakage and contact resistance, which can cause erroneous input offset voltage readings. The isolation techniques previously mentioned have no effect on the leakage since the moisture also covers the isolation metal itself, thereby rendering it useless. It is suggested that these measurements be performed at temperatures above freezing to minimize error.



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#### PARAMETER MEASUREMENT INFORMATION

### full-power response

Full-power response, the frequency above which the operational amplifier slew rate limits the output voltage swing, is often specified two ways: full-linear response and full-peak response. The full-linear response is generally measured by monitoring the distortion level of the output while increasing the frequency of a sinusoidal input signal until the maximum frequency is found above which the output contains significant distortion. The full-peak response is defined as the maximum output frequency, without regard to distortion, above which full peak-to-peak output swing cannot be maintained.

Because there is no industry-wide accepted value for significant distortion, the full-peak response is specified in this data sheet and is measured using the circuit of Figure 1. The initial setup involves the use of a sinusoidal input to determine the maximum peak-to-peak output of the device (the amplitude of the sinusoidal wave is increased until clipping occurs). The sinusoidal wave is then replaced with a square wave of the same amplitude. The frequency is then increased until the maximum peak-to-peak output can no longer be maintained (Figure 5). A square wave is used to allow a more accurate determination of the point at which the maximum peak-to-peak output is reached.

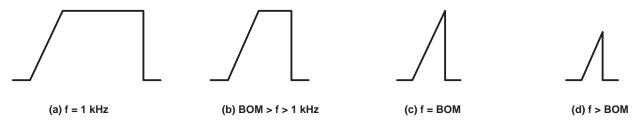


Figure 5. Full-Power-Response Output Signal

#### test time

Inadequate test time is a frequent problem, especially when testing CMOS devices in a high-volume, short-test-time environment. Internal capacitances are inherently higher in CMOS than in bipolar and BiFET devices and require longer test times than their bipolar and BiFET counterparts. The problem becomes more pronounced with reduced supply levels and lower temperatures.

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## **TYPICAL CHARACTERISTICS**

### **Table of Graphs**

			FIGURE
VIO	Input offset voltage	Distribution	6, 7
ανιο	Temperature coefficient of input offset voltage	Distribution	8, 9
Vон	High-level output voltage	vs High-level output current vs Supply voltage vs Free-air temperature	10, 11 12 13
VOL	Low-level output voltage	vs Common-mode input voltage vs Differential input voltage vs Free-air temperature vs Low-level output current	14, 15 16 17 18, 19
AVD	Large-signal differential voltage amplification	vs Supply voltage vs Free-air temperature vs Frequency	20 21 32, 33
I <sub>IB</sub>	Input bias current	vs Free-air temperature	22
liO	Input offset current	vs Free-air temperature	22
VIC	Common-mode input voltage	vs Supply voltage	23
I <sub>DD</sub>	Supply current	vs Supply voltage vs Free-air temperature	24 25
SR	Slew rate	vs Supply voltage vs Free-air temperature	26 27
	Normalized slew rate	vs Free-air temperature	28
V <sub>O(PP)</sub>	Maximum peak-to-peak output voltage	vs Frequency	29
B <sub>1</sub>	Unity-gain bandwidth	vs Free-air temperature vs Supply voltage	30 31
φm	Phase margin	vs Supply voltage vs Free-air temperature vs Load capacitance	34 35 36
٧n	Equivalent input noise voltage	vs Frequency	37
	Phase shift	vs Frequency	32, 33

#### TYPICAL CHARACTERISTICS

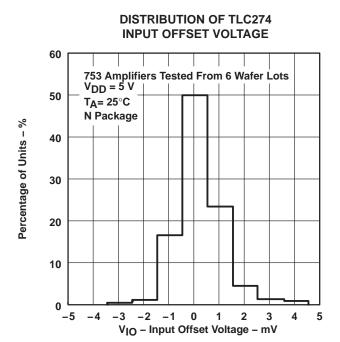
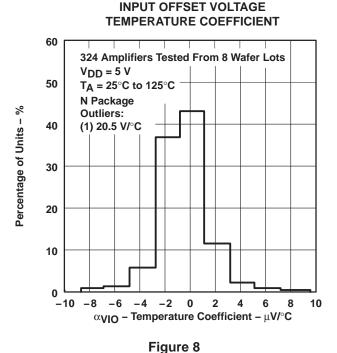


Figure 6

**DISTRIBUTION OF TLC274 AND TLC279** 



DISTRIBUTION OF TLC274

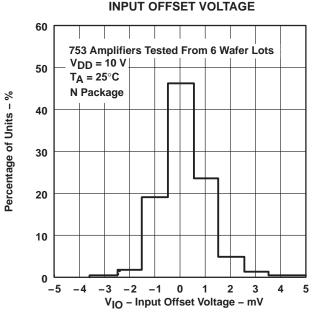


Figure 7

# DISTRIBUTION OF TLC274 AND TLC279 INPUT OFFSET VOLTAGE TEMPERATURE COEFFICIENT

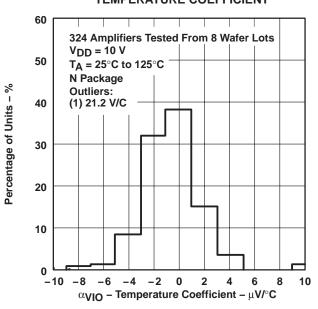


Figure 9

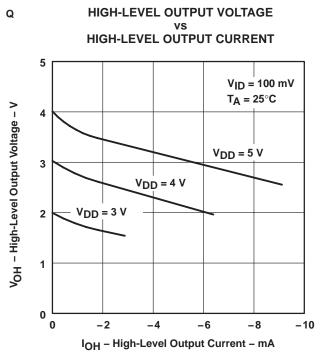
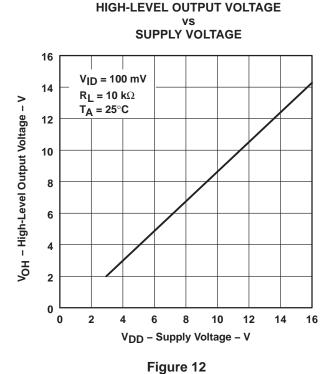


Figure 10



HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT

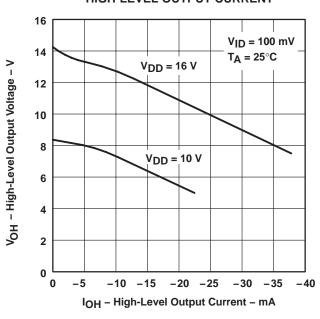


Figure 11

# HIGH-LEVEL OUTPUT VOLTAGE vs

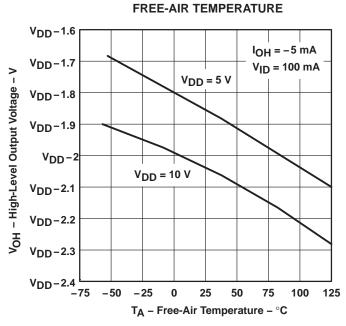


Figure 13

<sup>†</sup>Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



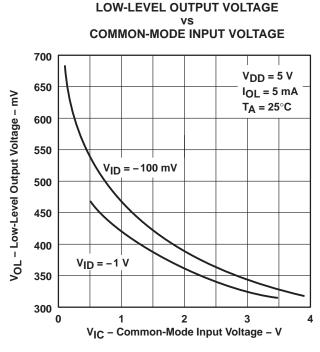
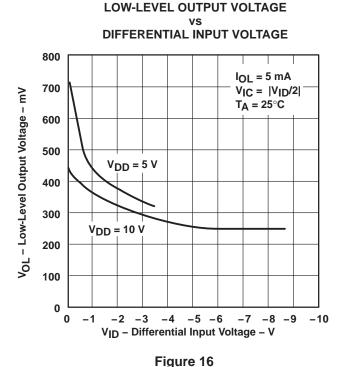


Figure 14



LOW-LEVEL OUTPUT VOLTAGE
vs
COMMON-MODE INPUT VOLTAGE

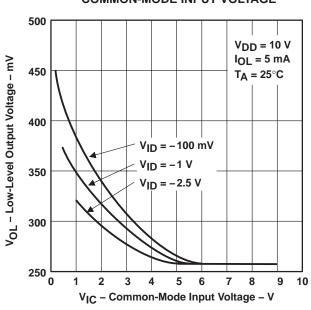


Figure 15

# LOW-LEVEL OUTPUT VOLTAGE vs FREE-AIR TEMPERATURE

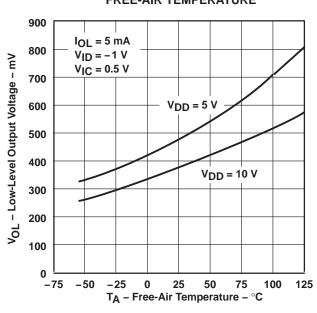


Figure 17

<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



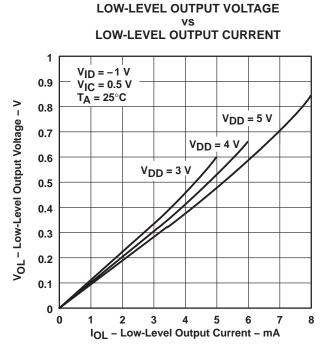
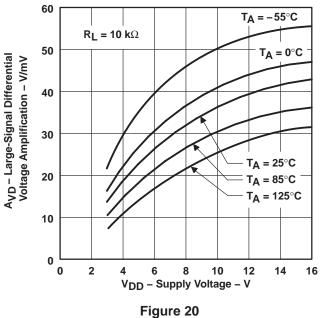


Figure 18

# **LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION SUPPLY VOLTAGE**



## LOW-LEVEL OUTPUT VOLTAGE LOW-LEVEL OUTPUT CURRENT

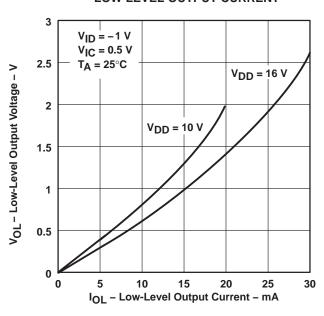


Figure 19

## LARGE-SIGNAL **DIFFERENTIAL VOLTAGE AMPLIFICATION** FREE-AIR TEMPERATURE

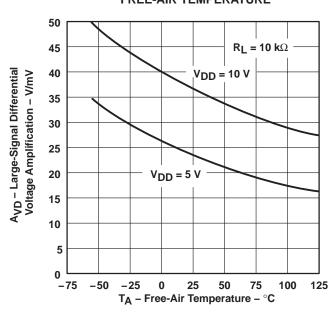


Figure 21

<sup>†</sup>Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



**COMMON-MODE INPUT VOLTAGE POSITIVE LIMIT** 

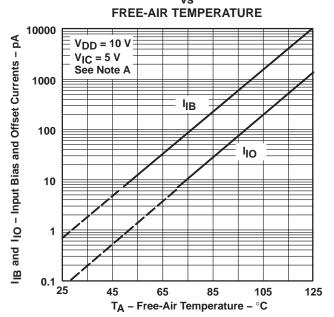
#### TYPICAL CHARACTERISTICS<sup>†</sup>

0

0

2

# INPUT BIAS CURRENT AND INPUT OFFSET CURRENT



NOTE A: The typical values of input bias current and input offset current below 5 pA were determined mathematically.

# vs **SUPPLY VOLTAGE** 16 $T_A = 25^{\circ}C$ 14 V<sub>IC</sub> - Common-Mode Input Voltage 12 10 8 6 2

Figure 22

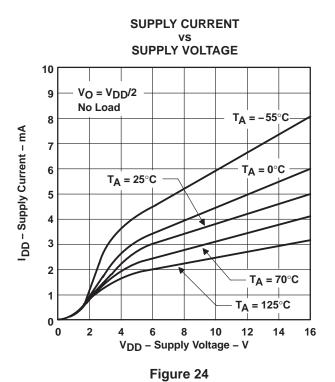


Figure 23

6

8

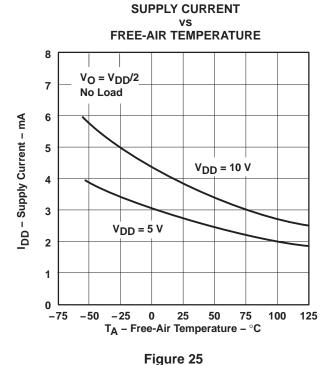
V<sub>DD</sub> - Supply Voltage - V

10

12

14

16



† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



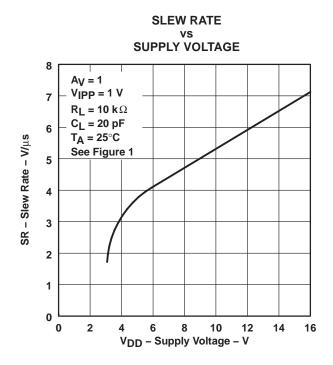


Figure 26

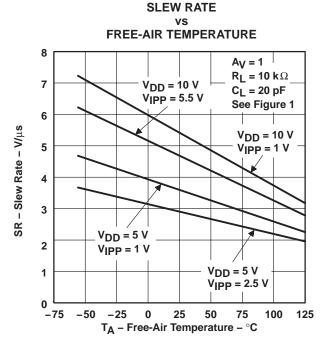
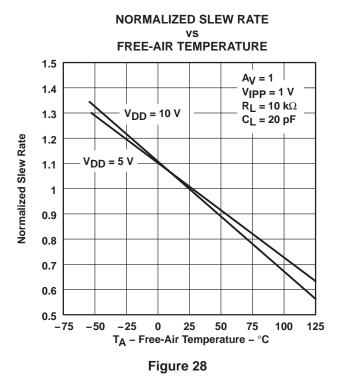


Figure 27

**MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE** 



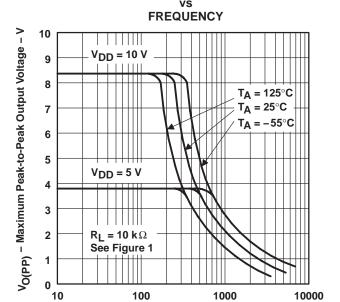
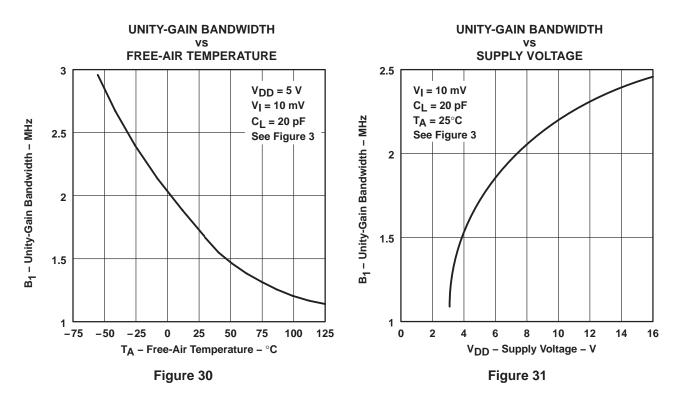


Figure 29

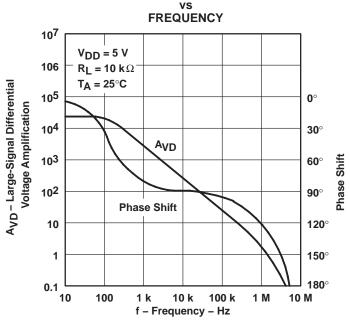
f - Frequency - kHz

<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





# LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION AND PHASE SHIFT



† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



Figure 32

#### LARGE-SIGNAL DIFFERENTIAL VOLTAGE **AMPLIFICATION AND PHASE SHIFT**

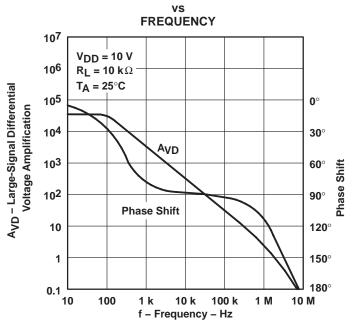
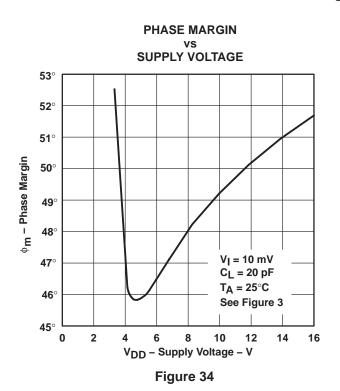
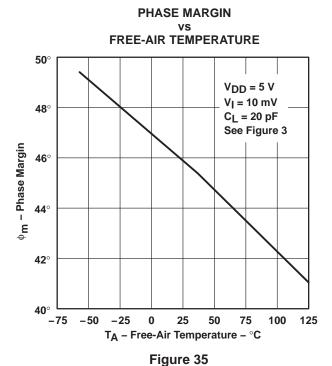


Figure 33





<sup>†</sup> Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



### **TYPICAL CHARACTERISTICS**

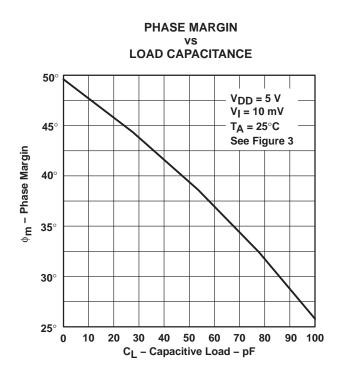


Figure 36

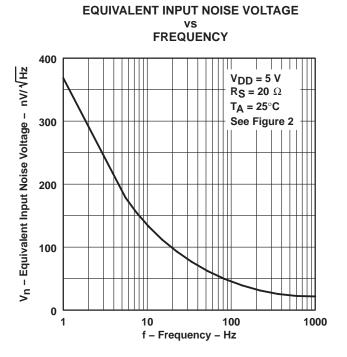


Figure 37

#### **APPLICATION INFORMATION**

#### single-supply operation

While the TLC274 and TLC279 perform well using dual power supplies (also called balanced or split supplies), the design is optimized for single-supply operation. This design includes an input common-mode voltage range that encompasses ground as well as an output voltage range that pulls down to ground. The supply voltage range extends down to 3 V (C-suffix types), thus allowing operation with supply levels commonly available for TTL and HCMOS; however, for maximum dynamic range, 16-V single-supply operation is recommended.

Many single-supply applications require that a voltage be applied to one input to establish a reference level that is above ground. A resistive voltage divider is usually sufficient to establish this reference level (see Figure 38). The low input bias current of the TLC274 and TLC279 permits the use of very large resistive values to implement the voltage divider, thus minimizing power consumption.

The TLC274 and TLC279 work well in conjunction with digital logic; however, when powering both linear devices and digital logic from the same power supply, the following precautions are recommended:

- 1. Power the linear devices from separate bypassed supply lines (see Figure 39); otherwise the linear device supply rails can fluctuate due to voltage drops caused by high switching currents in the digital logic.
- 2. Use proper bypass techniques to reduce the probability of noise-induced errors. Single capacitive decoupling is often adequate; however, high-frequency applications may require R<sub>C</sub> decoupling.

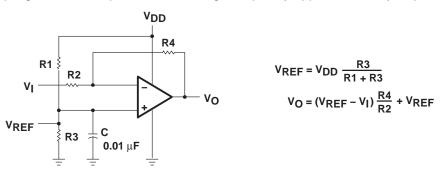


Figure 38. Inverting Amplifier With Voltage Reference

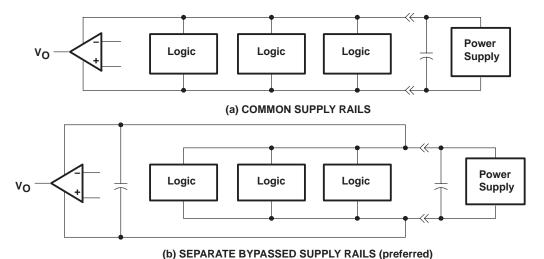


Figure 39. Common Versus Separate Supply Rails

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#### **APPLICATION INFORMATION**

#### input characteristics

The TLC274 and TLC279 are specified with a minimum and a maximum input voltage that, if exceeded at either input, could cause the device to malfunction. Exceeding this specified range is a common problem, especially in single-supply operation. Note that the lower range limit includes the negative rail, while the upper range limit is specified at  $V_{DD} - 1$  V at  $T_A = 25^{\circ}$ C and at  $V_{DD} - 1.5$  V at all other temperatures.

The use of the polysilicon-gate process and the careful input circuit design gives the TLC274 and TLC279 very good input offset voltage drift characteristics relative to conventional metal-gate processes. Offset voltage drift in CMOS devices is highly influenced by threshold voltage shifts caused by polarization of the phosphorus dopant implanted in the oxide. Placing the phosphorus dopant in a conductor (such as a polysilicon gate) alleviates the polarization problem, thus reducing threshold voltage shifts by more than an order of magnitude. The offset voltage drift with time has been calculated to be typically 0.1  $\mu$ V/month, including the first month of operation.

Because of the extremely high input impedance and resulting low bias current requirements, the TLC274 and TLC279 are well suited for low-level signal processing; however, leakage currents on printed-circuit boards and sockets can easily exceed bias current requirements and cause a degradation in device performance. It is good practice to include guard rings around inputs (similar to those of Figure 4 in the Parameter Measurement Information section). These guards should be driven from a low-impedance source at the same voltage level as the common-mode input (see Figure 40).

Unused amplifiers should be connected as grounded unity-gain followers to avoid possible oscillation.

#### noise performance

The noise specifications in operational amplifier circuits are greatly dependent on the current in the first-stage differential amplifier. The low input bias current requirements of the TLC274 and TLC279 result in a very low noise current, which is insignificant in most applications. This feature makes the devices especially favorable over bipolar devices when using values of circuit impedance greater than 50 k $\Omega$ , since bipolar devices exhibit greater noise currents.

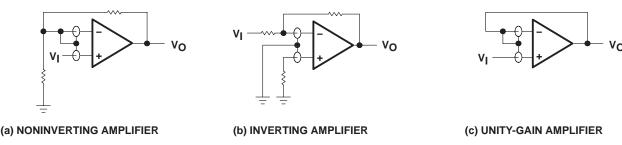


Figure 40. Guard-Ring Schemes

#### output characteristics

The output stage of the TLC274 and TLC279 is designed to sink and source relatively high amounts of current (see typical characteristics). If the output is subjected to a short-circuit condition, this high current capability can cause device damage under certain conditions. Output current capability increases with supply voltage.

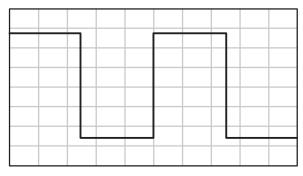
All operating characteristics of the TLC274 and TLC279 were measured using a 20-pF load. The devices drive higher capacitive loads; however, as output load capacitance increases, the resulting response pole occurs at lower frequencies, thereby causing ringing, peaking, or even oscillation (see Figure 41). In many cases, adding a small amount of resistance in series with the load capacitance alleviates the problem.



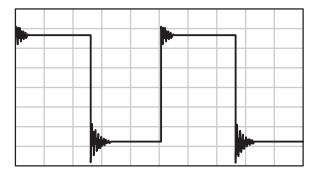
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#### **APPLICATION INFORMATION**

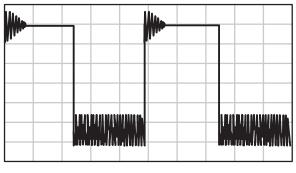
#### output characteristics (continued)



(a)  $C_L = 20 pF$ ,  $R_L = NO LOAD$ 



(b)  $C_L = 130 \text{ pF}$ ,  $R_L = NO \text{ LOAD}$ 



(c) C<sub>L</sub> = 150 pF, R<sub>L</sub> = NO LOAD

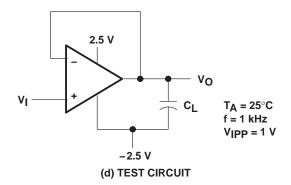
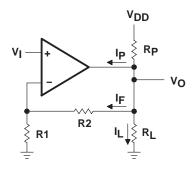


Figure 41. Effect of Capacitive Loads and Test Circuit

Although the TLC274 and TLC279 possess excellent high-level output voltage and current capability, methods for boosting this capability are available, if needed. The simplest method involves the use of a pullup resistor (Rp) connected from the output to the positive supply rail (see Figure 42). There are two disadvantages to the use of this circuit. First, the NMOS pulldown transistor N4 (see equivalent schematic) must sink a comparatively large amount of current. In this circuit, N4 behaves like a linear resistor with an on-resistance between approximately  $60~\Omega$  and  $180~\Omega$ , depending on how hard the op amp input is driven. With very low values of Rp, a voltage offset from 0 V at the output occurs. Second, pullup resistor Rp acts as a drain load to N4 and the gain of the operational amplifier is reduced at output voltage levels where N5 is not supplying the output current.

#### **APPLICATION INFORMATION**

### output characteristics (continued)



$$Rp = \frac{V_{DD} - V_{C}}{I_{E} + I_{I} + I_{E}}$$

Ip = Pullup current required by the operational amplifier (typically  $500 \mu A$ )

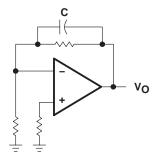


Figure 43. Compensation for Input Capacitance

### Figure 42. Resistive Pullup to Increase VOH

#### feedback

Operational amplifier circuits nearly always employ feedback, and since feedback is the first prerequisite for oscillation, some caution is appropriate. Most oscillation problems result from driving capacitive loads (discussed previously) and ignoring stray input capacitance. A small-value capacitor connected in parallel with the feedback resistor is an effective remedy (see Figure 43). The value of this capacitor is optimized empirically.

#### electrostatic discharge protection

The TLC274 and TLC279 incorporate an internal electrostatic discharge (ESD) protection circuit that prevents functional failures at voltages up to 2000 V as tested under MIL-STD-883C, Method 3015.2. Care should be exercised, however, when handling these devices as exposure to ESD may result in the degradation of the device parametric performance. The protection circuit also causes the input bias currents to be temperature-dependent and have the characteristics of a reverse-biased diode.

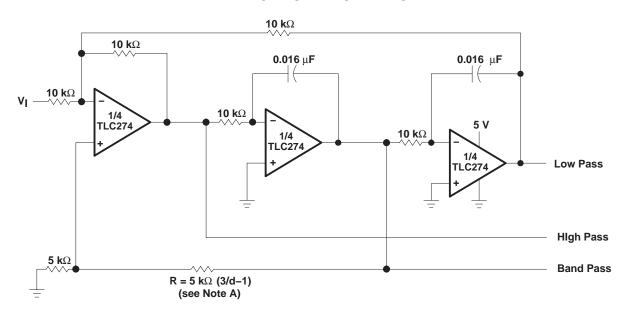
#### latch-up

Because CMOS devices are susceptible to latch-up due to their inherent parasitic thyristors, the TLC274 and TLC279 inputs and outputs were designed to withstand -100-mA surge currents without sustaining latch-up; however, techniques should be used to reduce the chance of latch-up whenever possible. Internal protection diodes should not, by design, be forward biased. Applied input and output voltage should not exceed the supply voltage by more than 300 mV. Care should be exercised when using capacitive coupling on pulse generators. Supply transients should be shunted by the use of decoupling capacitors (0.1  $\mu$ F typical) located across the supply rails as close to the device as possible.

The current path established if latch-up occurs is usually between the positive supply rail and ground and can be triggered by surges on the supply lines and/or voltages on either the output or inputs that exceed the supply voltage. Once latch-up occurs, the current flow is limited only by the impedance of the power supply and the forward resistance of the parasitic thyristor and usually results in the destruction of the device. The chance of latch-up occurring increases with increasing temperature and supply voltages.

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#### **APPLICATION INFORMATION**



NOTE A: d = damping factor, 1/Q

Figure 44. State-Variable Filter

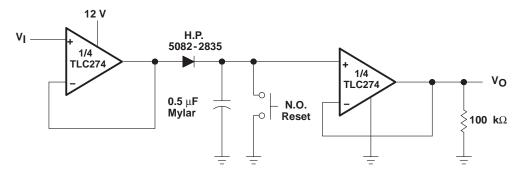
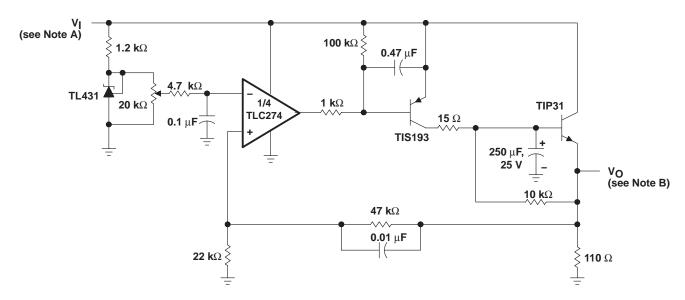


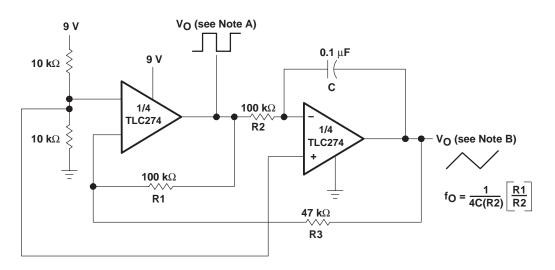
Figure 45. Positive-Peak Detector

### **APPLICATION INFORMATION**



NOTES: B.  $V_I = 3.5 \text{ V to } 15 \text{ V}$ C.  $V_O = 2 \text{ V}, 0 \text{ to } 1 \text{ A}$ 

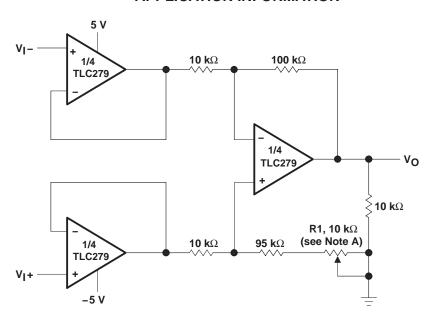
Figure 46. Logic-Array Power Supply



NOTES: A.  $V_{O(PP)} = 8 \text{ V}$ B.  $V_{O(PP)} = 4 \text{ V}$ 

Figure 47. Single-Supply Function Generator

### **APPLICATION INFORMATION**



NOTE C: CMRR adjustment must be noninductive.

Figure 48. Low-Power Instrumentation Amplifier

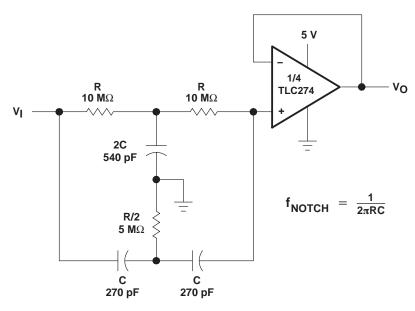


Figure 49. Single-Supply Twin-T Notch Filter

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## **PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
TLC274ACD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	TLC274AC
TLC274ACDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274AC
TLC274ACDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274AC
TLC274ACN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274ACN
TLC274ACN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274ACN
TLC274ACNE4	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274ACN
TLC274AID	Obsolete	Production	SOIC (D)   14	-	=	Call TI	Call TI	-40 to 85	TLC274AI
TLC274AIDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC274AI
TLC274AIDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC274AI
TLC274AIN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274AIN
TLC274AIN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274AIN
TLC274BCD	Obsolete	Production	SOIC (D)   14	-	=	Call TI	Call TI	0 to 70	TLC274BC
TLC274BCDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274BC
TLC274BCDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274BC
TLC274BCN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274BCN
TLC274BCN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274BCN
TLC274BCNE4	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274BCN
TLC274BCNS	Active	Production	SOP (NS)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274B
TLC274BCNS.A	Active	Production	SOP (NS)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274B
TLC274BID	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-40 to 85	TLC274BI
TLC274BIDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC274BI
TLC274BIDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC274BI
TLC274BIDRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	-	Call TI	Call TI	-40 to 85	
TLC274BIN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274BIN
TLC274BIN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274BIN
TLC274CDB	Active	Production	SSOP (DB)   14	80   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	P274
TLC274CDB.A	Active	Production	SSOP (DB)   14	80   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	P274
TLC274CDBR	Active	Production	SSOP (DB)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	P274
TLC274CDBR.A	Active	Production	SSOP (DB)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	P274





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TLC274CDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274C
TLC274CDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274C
TLC274CN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274CN
TLC274CN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274CN
TLC274CNE4	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC274CN
TLC274CNS	Active	Production	SOP (NS)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274
TLC274CNS.A	Active	Production	SOP (NS)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274
TLC274CNSR	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274
TLC274CNSR.A	Active	Production	SOP (NS)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC274
TLC274CPW	Obsolete	Production	TSSOP (PW)   14	-	=	Call TI	Call TI	0 to 70	P274
TLC274CPWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	P274
TLC274CPWR.A	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	P274
TLC274ID	Obsolete	Production	SOIC (D)   14	-	=	Call TI	Call TI	-40 to 85	TLC274I
TLC274IDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC274I
TLC274IDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC274I
TLC274IN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274IN
TLC274IN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274IN
TLC274INE4	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC274IN
TLC274IPWR	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 85	Y274
TLC274IPWR.A	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y274
TLC274IPWRG4	Active	Production	TSSOP (PW)   14	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	Y274
TLC274MD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-55 to 125	TLC274M
TLC274MDG4	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-55 to 125	TLC274M
TLC274MDRG4	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TLC274M
TLC274MDRG4.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TLC274M
TLC279CD	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	0 to 70	TLC279C
TLC279CDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC279C
TLC279CDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TLC279C
TLC279CN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC279CN
TLC279CN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TLC279CN
TLC279ID	Obsolete	Production	SOIC (D)   14	-	-	Call TI	Call TI	-40 to 85	TLC279I





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	(-)	(=/			(-)	(4)	(5)		(-)
TLC279IDR	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC279I
TLC279IDR.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TLC279I
TLC279IN	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC279IN
TLC279IN.A	Active	Production	PDIP (N)   14	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-40 to 85	TLC279IN

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



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### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLC274ACDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC274AIDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC274BCDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC274BIDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC274CDBR	SSOP	DB	14	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
TLC274CDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC274CNSR	SOP	NS	14	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
TLC274CPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC274CPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC274IDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC274IPWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC274IPWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC274IPWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TLC274MDRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC279CDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TLC279IDR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLC274ACDR	SOIC	D	14	2500	353.0	353.0	32.0
TLC274AIDR	SOIC	D	14	2500	353.0	353.0	32.0
TLC274BCDR	SOIC	D	14	2500	353.0	353.0	32.0
TLC274BIDR	SOIC	D	14	2500	353.0	353.0	32.0
TLC274CDBR	SSOP	DB	14	2000	353.0	353.0	32.0
TLC274CDR	SOIC	D	14	2500	333.2	345.9	28.6
TLC274CNSR	SOP	NS	14	2000	353.0	353.0	32.0
TLC274CPWR	TSSOP	PW	14	2000	353.0	353.0	32.0
TLC274CPWR	TSSOP	PW	14	2000	353.0	353.0	32.0
TLC274IDR	SOIC	D	14	2500	353.0	353.0	32.0
TLC274IPWR	TSSOP	PW	14	2000	356.0	356.0	35.0
TLC274IPWRG4	TSSOP	PW	14	2000	353.0	353.0	32.0
TLC274IPWRG4	TSSOP	PW	14	2000	356.0	356.0	35.0
TLC274MDRG4	SOIC	D	14	2500	353.0	353.0	32.0
TLC279CDR	SOIC	D	14	2500	353.0	353.0	32.0
TLC279IDR	SOIC	D	14	2500	353.0	353.0	32.0



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### **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
TLC274ACN	N	PDIP	14	25	506	13.97	11230	4.32
TLC274ACN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC274ACNE4	N	PDIP	14	25	506	13.97	11230	4.32
TLC274AIN	N	PDIP	14	25	506	13.97	11230	4.32
TLC274AIN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC274BCN	N	PDIP	14	25	506	13.97	11230	4.32
TLC274BCN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC274BCNE4	N	PDIP	14	25	506	13.97	11230	4.32
TLC274BCNS	NS	SOP	14	50	530	10.5	4000	4.1
TLC274BCNS.A	NS	SOP	14	50	530	10.5	4000	4.1
TLC274BIN	N	PDIP	14	25	506	13.97	11230	4.32
TLC274BIN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC274CDB	DB	SSOP	14	80	530	10.5	4000	4.1
TLC274CDB.A	DB	SSOP	14	80	530	10.5	4000	4.1
TLC274CN	N	PDIP	14	25	506	13.97	11230	4.32
TLC274CN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC274CNE4	N	PDIP	14	25	506	13.97	11230	4.32
TLC274CNS	NS	SOP	14	50	530	10.5	4000	4.1
TLC274CNS.A	NS	SOP	14	50	530	10.5	4000	4.1
TLC274IN	N	PDIP	14	25	506	13.97	11230	4.32
TLC274IN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC274INE4	N	PDIP	14	25	506	13.97	11230	4.32
TLC279CN	N	PDIP	14	25	506	13.97	11230	4.32
TLC279CN.A	N	PDIP	14	25	506	13.97	11230	4.32
TLC279IN	N	PDIP	14	25	506	13.97	11230	4.32
TLC279IN.A	N	PDIP	14	25	506	13.97	11230	4.32



SMALL OUTLINE INTEGRATED CIRCUIT



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-150.





- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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